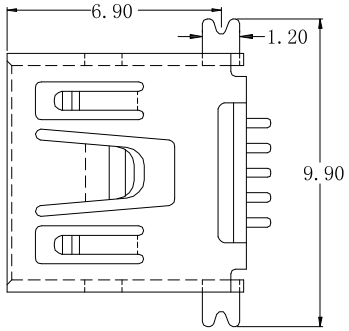
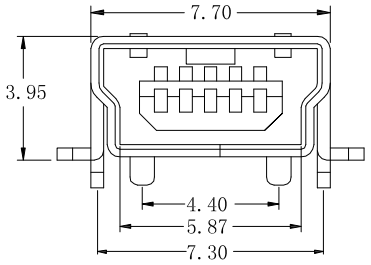
MUSB-5B-SD3-x-S175

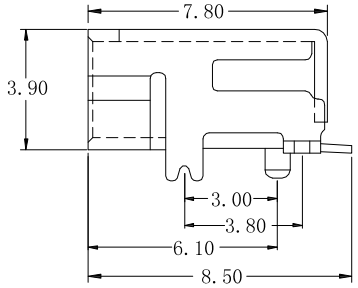
鍍層厚度 :

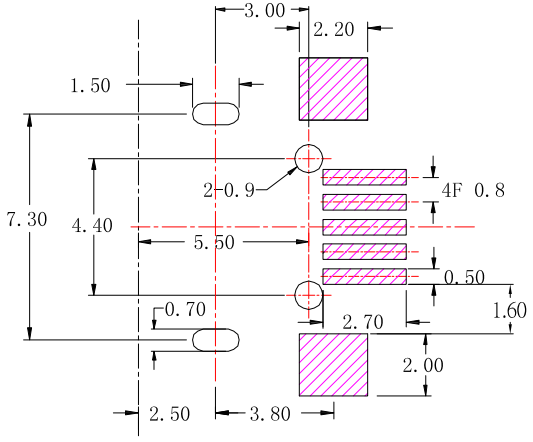
Blank : 1u"
2 : 15u"
3 : 30u"

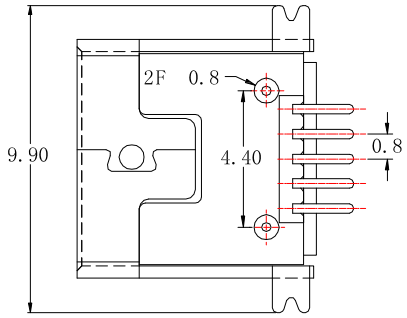


RoHS Compliant









P.C.B LAYOUT MOUNTING PATTERN

SPECIFICATIONS

Electrical :

1.Current Rating : 1.0A / contact terminal

2.Voltage Rating : 30V DC

3.Contact Resistance : 50 mΩ Max

4.Dielectric Withstanding Voltage : 300V AC

5.Insulation Resistance : 100 MΩ Min

Material :

1.Housing : LCP,UL 94V-0, Black

2.Contact : PHOSPHOR BRONZE

3.Shell : BRASS

Finish :

1.Contact : Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall

2.Shell : Nickel under Plated surface layer

ITEM NO.	DESCRIPTION	DRAWN	DATE
1	新增PCB LAYOUT尺寸	Jack	031218

建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2; Above 5 ~ 15 ±0.3; Above 15 ~ 30 ±0.4; Above 30 ~ 50 ±0.5; Angle ±0.3°

3RD. ANGEL'S | UNITS | MM

DRAWN BY: Jack Lu	DATE 03/12/18	MAT'L	
CHECKED BY: Jacky Chen	DATE 03/12/18	FINISH	
APPROVED BY: Tony Kao	DATE 03/12/18	SCALE 1 : 1	SHEET NO. 1 of 1

TITLE	CONNECTOR		
MODLE	MINI USB B TYPE SMT (SHELL : 前DIP後SMT)		
DWG NO.	MUSB-5B-SD3-x-S175	SIZE	A4
PART NO.	MUSB-5B-SD3-x-S175	VER	R1